

Product Update Memo

OPTIMIZATION PLANS

January, 2016

Bourns Optimization Plan Updates

Enclosed please find the most current Bourns Optimization Plans. Please review these sheets carefully so you are aware of products not recommended for new designs and note the dates for last order acceptance. Where available, alternatives are provided.

Sensors/Controls Optimization Plan

January, 2016

					20	16			20	17			20	18		Suggested
Model	Size	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
CT-23	27 mm	Turns-Counting Dial	TCD	G												H-22, H-23, H-516
CT-26	28 mm	Turns-Counting Dial	TCD	G												H-22, H-23, H-516
H-830		3310 Design Kit		G												H-830-1
H-831		3310 Design Kit		G												H-830-1

Notes:

Any models appearing on this plan are considered mature, are not recommended for new designs and are marked as such on the web site.

Type Codes:

- WW = Wirewound Precision Control
- HYB = Hybritron[®] Precision Control
- CP = Conductive Plastic Precision Control
- PC = Panel Control
- CE = Contacting Encoder
- OE = Optical Encoder
- TCD = Turns-Counting Dial
- SP = Slide Potentiometer

Scheduled for 2016 phase-out Scheduled for 2017 phase-out Scheduled for 2018 phase-out Events (occurs at end of indicated quarter):

 $\mathbf{A} = \mathbf{Develop} \text{ worldwide conversion plan to alternative.}$

B = Remove from new catalogs (increase price).

C = Remove from selected distribution channel cost and stockable lists (increase resale price).

D = Stop adding to MPOs.

- E = Remove from industrial/resale price list: issue supplemental price list; publish last order date (increase price, internal).
- F = Stop all orders except stock on hand.
- G = Stop production, dispose of inventory.

Trimmer Optimization Plan

January, 2016

					20	16			20	17			20	18		Suggested
Model	Size	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
							NO P	RODUC	TS CUR	RENTL	Y SCHED	ULED F	OR PHA	SE-OU	Γ.	

Type Codes:

Type Codes:	Events (occurs at end of indicated quarter):
MT = Multiturn	A = Develop worldwide conversion plan to alternative.
ST = Single-Turn	B = Remove from new catalogs (increase price).
TH = Through-Hole	C = Remove from selected distribution channel cost and stockable lists (increase resale price).
SMT = Surface Mount	D = Stop adding to MPOs.
	E = Remove from industrial/resale price list: issue supplemental price list; publish last order date (increase price, internal).
	F = Stop all orders except stock on hand.
	G = Stop production, dispose of inventory.

Notes:

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Switch Optimization Plan

January, 2016

					20	16			20	17			20	18		Suggested
Model	Size	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
						NO PR	ODUCT:	S CURR	ENTLY S	CHEDU	LED FOI	R PHAS	E-OUT.			

Events (occurs at end of indicated quarter):

A = Develop worldwide conversion plan to alternative.

B = Remove from new catalogs (increase price).

C = Remove from selected distribution channel cost and stockable lists (increase resale price).

D = Stop adding to MPOs.

E = Remove from industrial/resale price list: issue supplemental price list; publish last order date (increase price, internal).

F = Stop all orders except stock on hand.

G = Stop production, dispose of inventory.

Notes:

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Chips, Arrays, Networks, Specialty & Power Resistors Optimization Plan

January, 2016

					20	16			20	17			20	18		Suggested
Model	Size	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
CRP Series	0603-1206	Precision Chip Resistor	SMD	F		G										CRT
CRH Series	0603-1206	High Ohmic Chip Resistor	SMD	F		G										CR
PWR4522	11.45 x 5.5 mm	Fusible Safety Wirewound	TH				F		G							None
PWR4413B	11.43 x 13.5 x 0.8 mm	Bare Metal Shunt	TH		F		G									PWR4412-2SB
PWR4413C	15.24 x 16 x 1 mm	Bare Metal Shunt	TH		F		G									PWR4412-2SC
PWR4413D	20.32 x 26 x 1 mm	Bare Metal Shunt	TH		F		G									PWR4412-2SD
700 Series	10.11 - 40.59 x 8.5 x 3.81 mm	RC Terminator Networks	SIP		F		G									None
900 Series	10.2 - 35.6 x 5.08 x 3.81 mm	Capacitor Networks	SIP		F		G									None
CHF Series	10 - 1000 W	RF Power Resistors	FL/CH		F		G									None

Type Codes:

SIP = Single In-line Package DIP = Dual In-line Package SMD = Surface Mount Device 2NBS/2QSP = Thinfilm T0220 = T0220 Style Housing T0221 = T0221 Style Housing FL/CH = Flanged/Chip Events (occurs at end of indicated quarter):

A = Develop worldwide conversion plan to alternative.

B = Remove from new catalogs (increase price).

C = Remove from selected distribution channel cost and stockable lists (increase resale price).

D = Stop adding to MPOs.

E = Remove from industrial/resale price list: issue supplemental price list; publish last order date (increase price, internal).

F = Stop all orders except stock on hand.

G = Stop production, dispose of inventory.

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Scheduled for 2016 phase-out	
Scheduled for 2017 phase-out	
Scheduled for 2018 phase-out	

Magnetics Optimization Plan

January, 2016

					20)16			20	17			20	18		Suggested
Model	Size	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
06637-1A-RC	60 x 21 mm	Coil	РС		F		G									None
06754	107 x 63 mm	Coil, Dual	РС		F		G									None
07304	190 x 101 mm	Coil	РС		F		G									None
07356	162 x 58 mm	Coil	РС		F		G									None
07455-1	66 x 15 mm	RF Transformer	T		F		G									None
07469-1	66 x 15 mm	RF Transformer	T		F		G									None
07552	58 x 7 mm	Adjustable Inductor	РС		F		G									None
08446	53 x 23 mm	Adjustable Inductor	РС		F		G									None
08509-TR-RC	1.5 mm diameter	Air Coil	РС		F		G									None
08511-RC	3.8 x 14 mm	Air Coil	РС		F		G									None
08514-RC	6.9 mm diameter	Air Coil	РС		F		G									None
4534-RC	88 x 39 mm	Inductor	РС		F		G									None
4551	76 x 34 mm	Inductor	РС		F		G									None
4631-E	28 x 9 mm	Inductor	РС		F		G									None
CM100505	1 x 0.5 x 0.5 mm	Chip Inductor	CI		F		G									CI100505, CW100505
CM160808	1.6 x 0.8 x 0.8 mm	Chip Inductor	CI		F		G									CI160808, CW160808
FB43-110-RC	3.2 x 1 x 2.8 mm	Ferrite Bead	CB		F		G									None
FB43-226-RC	3.2 x 1 x 5.6 mm	Ferrite Bead	CB		F		G									None
FB43-287-RC	7.1 x 2.1 x 7.1 mm	Ferrite Bead	CB		F		G									None
FB43-422-RC	4.6 x 1.2 x 10.4 mm	Ferrite Bead	CB		F		G									None
FB64-110-RC	3.2 x 1 x 2.8 mm	Ferrite Bead	CB		F		G									None
FB73-085-RC	1.3 x 0.68 x 2.1 mm	Ferrite Bead	CB		F		G									None
FB73-110-RC	3.2 x 1 x 2.8 mm	Ferrite Bead	CB		F		G									None
FB73-226-RC	3.2 x 1 x 5.6 mm	Ferrite Bead	CB		F		G									None
FB73-422-RC	4.6 x 1.2 x 10.4 mm	Ferrite Bead	CB		F		G									None
PT72589L	12.7 x 6.8 x 4.5 mm	Transformer	T		F		G									None
PT74901-1EL	12.7 x 6.8 x 4.5 mm	Transformer	T		F		G									None
PT75638-1EL	12.7 x 6.8 x 4.5 mm	Transformer	T		F		G									None
PT91008L	66 x 15 mm	RF Transformer	T		F		G									None
SRP1055	11 x 9.5 x 5.5 mm	Power Inductor	РС		F		G									None

Type Codes:

Cl = Chip Inductor

PC = Power Inductor

- $\mathsf{CMC}=\mathsf{Common}\,\mathsf{Mode}\,\mathsf{Choke}$
- T = Transformer
- $\mathsf{CB} \ = \mathsf{Chip} \, \mathsf{Bead}$

Events (occurs at end of indicated quarter):

A = Develop worldwide conversion plan to alternative.

B = Remove from new catalogs (increase price).

C = Remove from selected distribution channel cost and stockable lists (increase resale price).

D = Stop adding to MPOs.

E = Remove from industrial/resale price list: issue supplemental price list; publish last order date (increase price, internal).

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Scheduled for 2016 phase-out
Scheduled for 2017 phase-out
Scheduled for 2018 phase-out

Multifuse[®] PTC Optimization Plan

January, 2016

				20	16			20	17			20	18		Suggested
Model	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
					NC	PRODU	CTS CUR	RENTLY S	CHEDUL	ED FOR I	PHASE-O	UT.			

Type Codes:	Events (occurs at end of indicated quarter):
R = Radial Leaded	A = Develop worldwide conversion plan to alternative.
S = Strap	B = Remove from new catalogs (increase price).
SMT = Surface Mount	C = Remove from selected distribution channel cost and stockable lists (increase resale price).
	D = Stop adding to MPOs.
	E = Remove from industrial/resale price list: issue supplemental price list; publish last order date (increase price, internal).
	F = Stop all orders except stock on hand.
	G = Stop production, dispose of inventory.

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Semiconductor Products Optimization Plan

January, 2016

			2016					20	17			20	18		Suggested
Model	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
CD0603-B00340	Chip Diode	CD	B, D		E, F	G									
CD0603-B0130	Chip Diode	CD	B, D		E, F	G									
CD0603-B0130L	Chip Diode	CD	B, D		E, F	G									
CD0603-B0140L	Chip Diode	CD	B, D		E, F	G									
CD0603-B0140R	Chip Diode	CD	B, D		E, F	G									
CD0603-B0230	Chip Diode	CD	B, D		E, F	G									
CD0603-B0240	Chip Diode	CD	B, D		E, F	G									
CD0603-S0180	Chip Diode	CD	B, D		E, F	G									
CD0603-S0180R	Chip Diode	CD	B, D		E, F	G									
CD0603-T05C	Chip Diode	CD	B, D		E, F	G									
CD0603-T12C	Chip Diode	CD	B, D		E, F	G									
CD0603-T24C	Chip Diode	CD	B, D		E, F	G									
CD0603-T36C	Chip Diode	CD	B, D		E, F	G									
CD0603-Z10	Chip Diode	CD	B, D		E, F	G									
CD0603-Z11	Chip Diode	CD	B, D		E, F	G									
CD0603-Z12	Chip Diode	CD	B, D		E, F	G									
CD0603-Z13	Chip Diode	CD	B, D		E, F	G									
CD0603-Z15	Chip Diode	CD	B, D		E, F	G									
CD0603-Z16	Chip Diode	CD	B, D		E, F	G									
CD0603-Z18	Chip Diode	CD	B, D		E, F	G									
CD0603-Z2	Chip Diode	CD	B, D		E, F	G									
CD0603-Z20	Chip Diode	CD	B, D		E, F	G									
CD0603-Z22	Chip Diode	CD	B, D		E, F	G									
CD0603-Z24	Chip Diode	CD	B, D		E, F	G									
CD0603-Z27	Chip Diode	CD	B, D		E, F	G									
CD0603-Z2V2	Chip Diode	CD	B, D		E, F	G									
CD0603-Z2V4	Chip Diode	CD	B, D		E, F	G									
CD0603-Z2V7	Chip Diode	CD	B, D		E, F	G									
CD0603-Z3	Chip Diode	CD	B, D		E, F	G									
CD0603-Z30	Chip Diode	CD	B, D		E, F	G									
CD0603-Z33	Chip Diode	CD	B, D		E, F	G									
CD0603-Z36	Chip Diode	CD	B, D		E, F	G									
CD0603-Z39	Chip Diode	CD	B, D		E, F	G									
CD0603-Z3V3	Chip Diode	CD	B, D		E, F	G									
CD0603-Z3V6	Chip Diode	CD	B, D		E, F	G									
CD0603-Z3V9	Chip Diode	CD	B, D		E, F	G									
CD0603-Z4V3	Chip Diode	CD	B, D		E, F	G									
CD0603-Z4V7	Chip Diode	CD	B, D		E, F	G									
CD0603-Z5V1	Chip Diode	CD	B, D		E, F	G									
CD0603-Z5V6	Chip Diode	CD	B, D		E, F	G									
CD0603-Z6V2	Chip Diode	CD	B, D		E, F	G									
CD0603-Z6V8	Chip Diode	CD	B, D		E, F	G									
CD0603-Z7V5	Chip Diode	CD	B, D		E, F	G									

Semiconductor Products Optimization Plan (Continued)

January, 2016

				20)16			20	017			20	18		Suggested
Model	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
CD0603-Z8V2	Chip Diode	CD	B, D		E, F	G									
CD0603-Z9V1	Chip Diode	CD	B, D		E, F	G									
CD1005-B00340	Chip Diode	CD	B, D		E, F	G									
CD1005-B0130	Chip Diode	CD	B, D		E, F	G									
CD1005-B0130L	Chip Diode	CD	B, D		E, F	G									
CD1005-B0140L	Chip Diode	CD	B, D		E, F	G									
CD1005-B0140R	Chip Diode	CD	B, D		E, F	G									
CD1005-B0230	Chip Diode	CD	B, D		E, F	G									
CD1005-B0240	Chip Diode	CD	B, D		E, F	G									
CD1005-B0520	Chip Diode	CD	B, D		E, F	G									
CD1005-S01575	Chip Diode	CD	B, D		E, F	G									
CD1005-S0180	Chip Diode	CD	B, D		E, F	G									
CD1005-S0180R	Chip Diode	CD	B, D		E, F	G									
CD1005-T05C	Chip Diode	CD	B, D		E, F	G									
CD1005-T12C	Chip Diode	CD	B, D		E, F	G									
CD1005-T24C	Chip Diode	CD	B, D		E, F	G									
CD1005-T36C	Chip Diode	CD	B, D		E, F	G									
CD1005-Z10	Chip Diode	CD	B, D		E, F	G									
CD1005-Z11	Chip Diode	CD	B, D		E, F	G									
CD1005-Z12	Chip Diode	CD	B, D		E, F	G									
CD1005-Z13	Chip Diode	CD	B, D		E, F	G									
CD1005-Z15	Chip Diode	CD	B, D		E, F	G									
CD1005-Z16	Chip Diode	CD	B, D		E, F	G									
CD1005-Z18	Chip Diode	CD	B, D		E, F	G									
CD1005-Z2	Chip Diode	CD	B, D		E, F	G									
CD1005-Z20	Chip Diode	CD	B, D		E, F	G									
CD1005-Z22	Chip Diode	CD	B, D		E, F	G									
CD1005-Z24	Chip Diode	CD	B, D		E, F	G									
CD1005-Z27	Chip Diode	CD	B, D		E, F	G									
CD1005-Z29	Chip Diode	CD	B, D		E, F	G									
CD1005-Z2V2	Chip Diode	CD	B, D		E, F	G									
CD1005-Z2V4	Chip Diode	CD	B, D		E, F	G									
CD1005-Z2V7	Chip Diode	CD	B, D		E, F	G									
CD1005-Z3	Chip Diode	CD	B, D		E, F	G									
CD1005-Z30	Chip Diode	CD	B, D		E, F	G									
CD1005-Z33	Chip Diode	CD	B, D		E, F	G									
CD1005-Z36	Chip Diode	CD	B, D		E, F	G									
CD1005-Z39	Chip Diode	CD	B, D		E, F	G									
CD1005-Z3V3	Chip Diode	CD	B, D		E, F	G									
CD1005-Z3V6	Chip Diode	CD	B, D		E, F	G									
CD1005-Z3V9	Chip Diode	CD	B, D		E, F	G									
CD1005-Z4V3	Chip Diode	CD	B, D		E, F	G									
CD1005-Z4V7	Chip Diode	CD	B, D		E, F	G									
CD1005-Z5V1	Chip Diode	CD	B, D		E, F	G									
CD1005-Z5V6	Chip Diode	CD	B, D		E, F	G									
CD1005-Z6V2	Chip Diode	CD	B, D		E, F	G									
CD1005-Z6V8	Chip Diode	CD	B, D		E, F	G									

Semiconductor Products Optimization Plan (Continued)

January, 2016

	Description			20	16		20	17			20	Suggested			
Model		Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
CD1005-Z7V5	Chip Diode	CD	B, D		E, F	G									
CD1005-Z8V2	Chip Diode	CD	B, D		E, F	G									
CD1005-Z9V1	Chip Diode	CD	B, D		E, F	G									
CD1607-B140LF	Chip Diode	CD	B, D		E, F	G									
CD1607-B120LLF	Chip Diode	CD	B, D		E, F	G									
CD1607-B140LLF	Chip Diode	CD	B, D		E, F	G									
CDDFN2-T12C	Chip Diode	CD	B, D		E, F	G									
CDDFN2-T24C	Chip Diode	CD	B, D		E, F	G									
CDDFN2-T4.7C	Chip Diode	CD	B, D		E, F	G									
CDDFN2-T5.0C	Chip Diode	CD	B, D		E, F	G									
CDS0T23-S2004	Chip Diode	CD	B, D		E, F	G									
CDSOT563-T05C	Chip Diode	CD	B, D		E, F	G									
CDSOT363-T05C	Chip Diode	CD	B, D		E, F	G									
CDWBS16-PLC01-6	Chip Diode	CD			B, D		E, F		G						
TISP4C015L1NR-S	Thyristor Surge Protector	TSP	B, D		E, F		G								
TISP4C020L1NR-S	Thyristor Surge Protector	TSP	B, D		E, F		G								
TISP4C025L1NR-S	Thyristor Surge Protector	TSP	B, D		E, F		G								
TISP4C035L1NR-S	Thyristor Surge Protector	TSP	B, D		E, F		G								
TISP6NTP2ADR-S	Thyristor Surge Protector	TSP	F		G										
TISP4300MMAJR-S	Thyristor Surge Protector	TSP	F		G										
TISP4300MMBJR-S	Thyristor Surge Protector	TSP	F		G										
TISP4350MMAJR-S	Thyristor Surge Protector	TSP	F		G										
TISP4350MMBJR-S	Thyristor Surge Protector	TSP	F		G										
TISP4360MMAJR-S	Thyristor Surge Protector	TSP	F		G										
TISP4360MMBJR-S	Thyristor Surge Protector	TSP	F		G										
TISP61089BGDR-S	Thyristor Surge Protector	TSP	F		G										
TISP61511DR-S	Thyristor Surge Protector	TSP	F		G										

Type Codes:

CD = Chip DiodeTBU = TBU[®] HSP Product TSP = TISP[®] Product Events (occurs at end of indicated quarter):

- A = Develop worldwide conversion plan to alternative.
- B = Remove from new catalogs (increase price).
- C = Remove from selected distribution channel cost and stockable lists (increase resale price).
- D = Stop adding to MPOs.
- E = Remove from industrial/resale price list: issue supplemental price list; publish last order date (increase price, internal).
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GDT Optimization Plan

January, 2016

			2016					20)17			20	Suggested		
Model	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
			NO PRODUCTS CURRENTLY SCHEDULED FOR PHASE-OUT.												

Type Codes:	Events (occurs at end of indicated quarter):
GDT = Gas Discharge Tube	A = Develop worldwide conversion plan to alternative.
	B = Remove from new catalogs (increase price).
	C = Remove from selected distribution channel cost and stockable lists (increase resale price).
	D = Stop adding to MPOs.
	E = Remove from industrial/resale price list: issue supplemental price list; publish last order date (increase price, internal).

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Metal Oxide Varistor (MOV) Optimization Plan

January, 2016

			2016					20	17			20	Suggested		
Model	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
MOV-07DxxxK	7mm Metal Oxide Varistor	MOV				E, F		G							
MOV-10DxxxK	10mm Metal Oxide Varistor	MOV				E, F		G							
MOV-14DxxxK	14mm Metal Oxide Varistor	MOV				E, F		G							
MOV-20DxxxK	20mm Metal Oxide Varistor	MOV				E, F		G							

Type Codes:

MOV = Metal Oxide Varistor

Events (occurs at end of indicated quarter):

A = Develop worldwide conversion plan to alternative.

B = Remove from new catalogs (increase price).

C = Remove from selected distribution channel cost and stockable lists (increase resale price).

D = Stop adding to MPOs.

E = Remove from industrial/resale price list: issue supplemental price list; publish last order date (increase price, internal).

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Notes:

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ChipGuard® ESD Suppressor Optimization Plan

January, 2016

			2016					20	17			20	Suggested		
Model	Description	Туре	1	2	3	4	1	2	3	4	1	2	3	4	Alternative
CG0402MLA-14KG	ChipGuard [®] ESD Suppressor 0402 VDC 14V	CG	E, F	G											
CG0603MLA-14KE	ChipGuard [®] ESD Suppressor 0603 VDC 14V	G	E, F	G											

Type Codes:

CG = ChipGuard[®] ESD Suppressor

Events (occurs at end of indicated quarter):

A = Develop worldwide conversion plan to alternative.

B = Remove from new catalogs (increase price).

C = Remove from selected distribution channel cost and stockable lists (increase resale price).

D = Stop adding to MPOs.

E = Remove from industrial/resale price list: issue supplemental price list; publish last order date (increase price, internal).

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